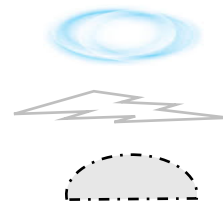


Surface pick-up point (relay)



Implant nodes



Field pattern around electrodes

Implant to implant communication (M-M)

Implant to surface communication (M-S)